

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>SeungYong Chai</td> <td>03/25/2009</td> </tr> <tr> <td>Sang-Ho Lee</td> <td>03/25/2009</td> </tr> </tbody> </table>		Name	Execution Date	SeungYong Chai	03/25/2009	Sang-Ho Lee	03/25/2009
Name	Execution Date						
SeungYong Chai	03/25/2009						
Sang-Ho Lee	03/25/2009						
RECEIVING PARTY DATA							
Name:	STATS ChipPAC Ltd.						
Street Address:	10 Ang Mo Kio Street 65						
Internal Address:	#05-17/20 Techpoint						
City:	Singapore						
State/Country:	SINGAPORE						
Postal Code:	569059						
PROPERTY NUMBERS Total: 1							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12411390</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12411390		
Property Type	Number						
Application Number:	12411390						
CORRESPONDENCE DATA							
Fax Number:	(408)738-0881						
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>							
Phone:	408-738-0592						
Email:	efiling@ishimarulaw.com						
Correspondent Name:	LAW OFFICES OF MIKIO ISHIMARU						
Address Line 1:	333 W. EL CAMINO REAL						
Address Line 2:	SUITE 330						
Address Line 4:	SUNNYVALE, CALIFORNIA 94087						
ATTORNEY DOCKET NUMBER:	27-629						
NAME OF SUBMITTER:	Mikio Ishimaru						

Total Attachments: 2
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PATENT
REEL: 022483 FRAME: 0047

CH \$40.00 12411390

ASSIGNMENT

WHEREAS, the undersigned (hereinafter termed Assignor(s)) has/have invented certain new and useful improvements in

INTEGRATED CIRCUIT PACKAGING SYSTEM WITH MULTI-STACKED FLIP CHIPS AND METHOD OF MANUFACTURE THEREOF

for which a United States patent application has been executed on or before the date of this assignment;

WHEREAS, STATS ChipPAC Ltd., a Corporation of the Republic of Singapore, having a place of business at 10 Ang Mo Kio Street 65, #05-17/20 Techpoint, Singapore 569059, Republic of Singapore (hereinafter termed Assignee), is desirous of acquiring the entire right, title and interest in and to said application and said invention and improvements thereon, and in and to Letters Patents thereon when granted in the United States and foreign countries;

NOW, THEREFORE, for good and valuable consideration received by said Assignor(s) from said Assignee, the receipt of which is hereby acknowledged by said Assignor(s):

1. Said Assignor(s) does hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest in and to said application and said invention and in and to any and all improvements on said invention and in and to any and all improvements on said invention heretofore or hereafter made or acquired by said Assignor(s); and in and to any and all Letters Patent on said invention and/or said improvements that may be granted in the United States or any foreign country, including each and every Letters Patent granted on any application which is a division, continuation, substitution, renewal, or continuation-in-part of any said application, and in and to each and every reissue or extension of said Letters Patent.
2. Said Assignor(s) hereby covenants and agrees to cooperate with said Assignee where said Assignee may enjoy to the fullest extent the right, title and interest herein conveyed. Such cooperation shall include (a) prompt execution of all papers (prepared at the expense of Assignee) which are deemed necessary or desirable by Assignee to perfect in it the right, title and interest herein conveyed, (b) prompt execution of all petitions, oaths, specifications or other papers (prepared at the expense of Assignee) which are deemed necessary or desirable by assignee for prosecuting said application, for filing and prosecuting divisional, continuation, substitution, renewal, continuation-in-part, or additional applications in the United States and/or foreign countries covering said invention and/or said improvements, for filing and prosecuting applications for reissuance of letters patent included herein, or for interference proceedings involving said invention and/or said improvements and (c) prompt assistance and cooperation in the prosecution of interference proceedings involving said invention and/or said improvements and in the adjudication of said Letters Patent, particularly by the disclosure of facts and the production of evidence relating to said invention and/or said improvements, provided the expenses which may be incurred by said Assignor(s) in lending such assistance and cooperation shall be paid by the Assignee.
3. The terms, covenants and conditions of this assignment shall inure to the benefit of said Assignee, its successors, assigns and/or other legal representatives and shall be binding upon said Assignor(s), his/her heirs, legal representatives and assigns.
4. Said Assignor(s) hereby warrants and represents that he/she has not entered into any assignment, contract or understanding in conflict herewith.

5. Said Assignor(s) hereby authorize and request the attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow:

Serial Number: 12/411,390 Filing Date: March 25, 2009

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

Chai SY
SeungYong Chai

Mar 25 '09
Date

[Signature]
Witness Signature

[Signature]
Witness Signature

Choi Dae Sik
Print Witness Name

Soo Eun Park
Print Witness Name

Mar 25 '09
Date

Mar 25 '09
Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

[Signature]
Sang-Ho Lee

Mar 25 '09
Date

[Signature]
Witness Signature

[Signature]
Witness Signature

Choi Dae Sik
Print Witness Name

Soo Eun Park
Print Witness Name

Mar 25 '09
Date

Mar 25 '09
Date